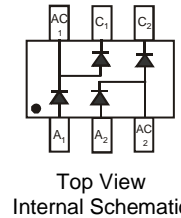


## Features

- Two Series Diode Circuits Connect to Form Full Wave Bridge
- Fast Switching Speed: Maximum of 50ns
- High Reverse Breakdown Voltage Rating: 350V
- Low Reverse Current: Maximum of 100nA when  $V_R = 240V$  at Room Temperature
- New Cutting-Edge Process Technology Used
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

## Mechanical Data

- Package: SOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Plated Leads (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 (63)
- Polarity: See Diagram
- Weight: 0.016 grams (Approximate)

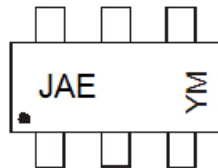


## Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
DHVSD3004BRM-7	SOT26	3,000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



JAE = Product Type Marking Code  
 YM = Date Code Marking; A Bar on Top of the 'Y'  
 Denotes Assembly & Test Site  
 Y = Year (ex: L = 2024)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	M	N	P	R	S	T	U	V	W

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	350	V
Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RWM</sub> V <sub>R</sub>	300	V
Forward Continuous Current (Note 5)	I <sub>F</sub>	225	mA
Peak Repetitive Forward Current (Note 5)	I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current	I <sub>FSM</sub>	@ t = 1.0μs	4.0
		@ t = 10ms	1.0
		@ t = 1.0s	0.5

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	350	—	—	V	I <sub>R</sub> = 150μA
Forward Voltage	V <sub>F</sub>	—	—	0.87	V	I <sub>F</sub> = 20mA
		—	—	1.05		I <sub>F</sub> = 100mA
		—	—	1.20		I <sub>F</sub> = 200mA
Reverse Current (Note 6)	I <sub>R</sub>	—	—	100	nA	V <sub>R</sub> = 240V
		—	—	35	μA	V <sub>R</sub> = 240V, T <sub>J</sub> = +150°C
Total Capacitance	C <sub>T</sub>	—	—	5.0	pF	V <sub>R</sub> = 0V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	—	—	50	ns	I <sub>F</sub> = I <sub>R</sub> = 10mA I <sub>rr</sub> = 0.1 x I <sub>R</sub> , R <sub>L</sub> = 100Ω

Notes: 5. Part mounted on FR-4 board 1inch squared cu pad layout.  
6. Short duration pulse test used to minimize self-heating effect.

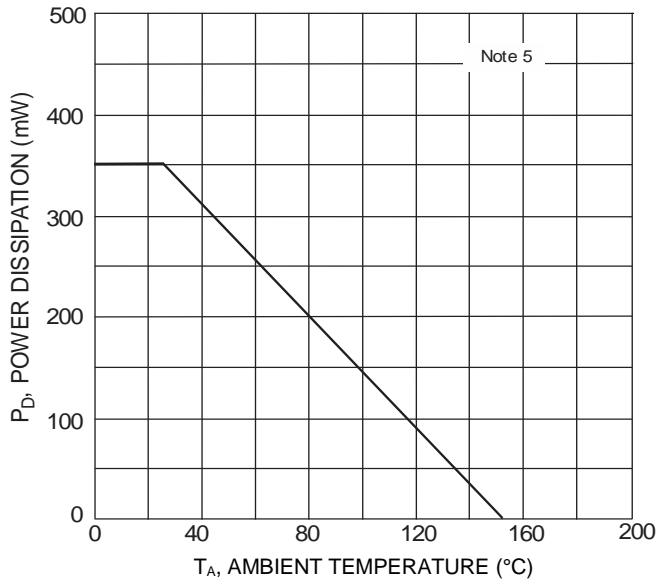


Figure 1. Power Derating Curve, Total Package

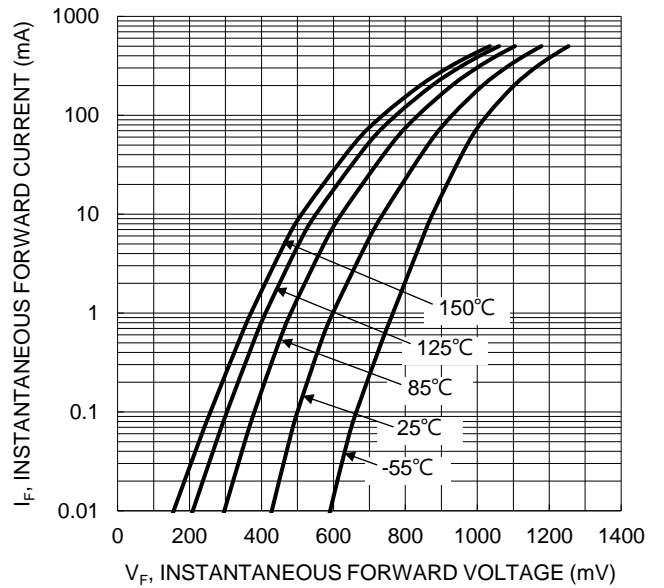


Figure 2. Typical Forward Characteristics, Per Element

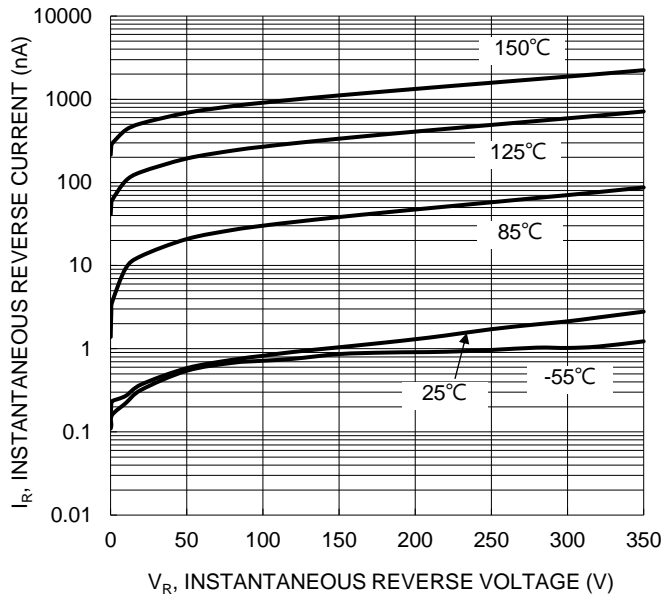


Figure 3. Typical Reverse Characteristics, Per Element

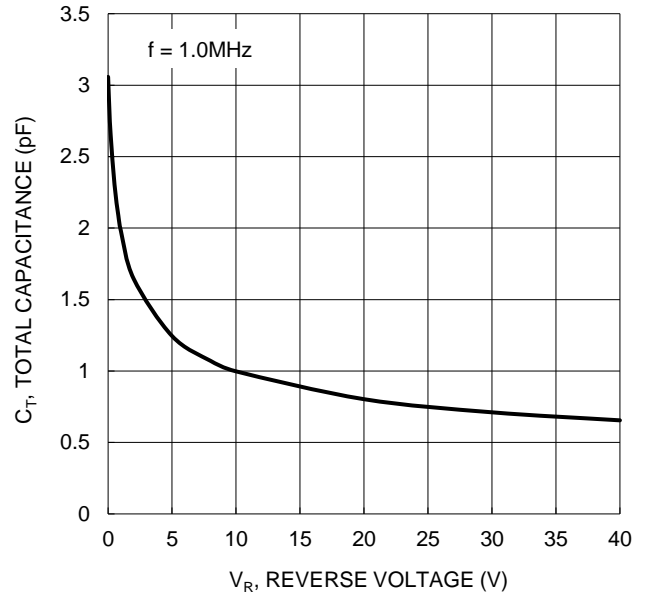
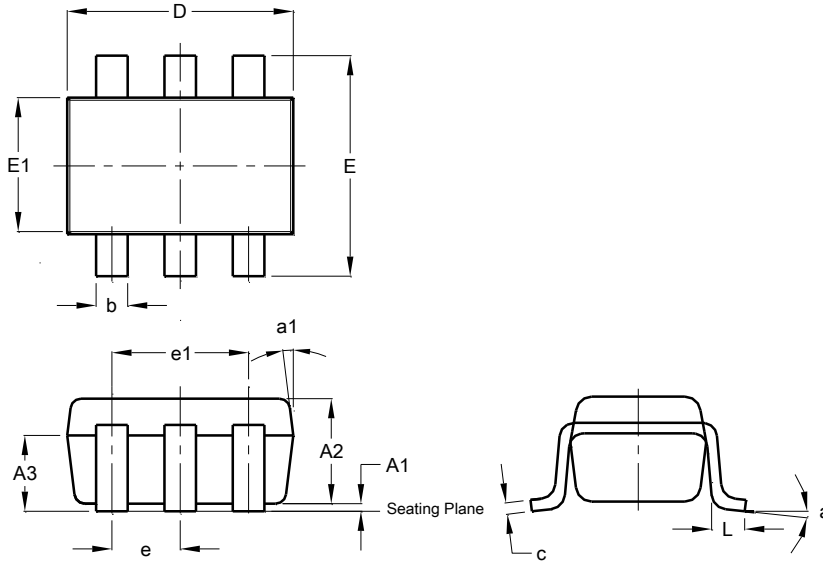


Figure 4. Typical Total Capacitance, Per Element

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT26**

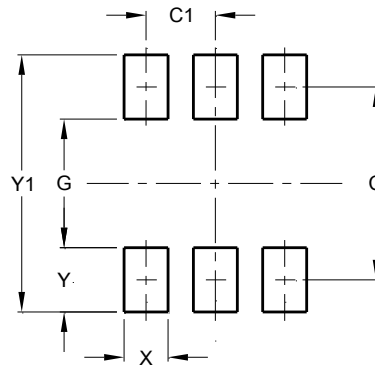


SOT26			
Dim	Min	Max	Typ
A1	0.013	0.10	0.05
A2	1.00	1.30	1.10
A3	0.70	0.80	0.75
b	0.35	0.50	0.38
c	0.10	0.20	0.15
D	2.90	3.10	3.00
e	-	-	0.95
e1	-	-	1.90
E	2.70	3.00	2.80
E1	1.50	1.70	1.60
L	0.35	0.55	0.40
a	-	-	8°
a1	-	-	7°
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT26**



Dimensions	Value (in mm)
C	2.40
C1	0.95
G	1.60
X	0.55
Y	0.80
Y1	3.20

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